

# Weld Ductility Studies of a Tin-Modified Copper-Nickel Alloy

*Manganese and phosphorus additions eliminated cracking that resulted from gamma formation at grain boundaries*

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**ABSTRACT.** The ductility of gas tungsten arc (GTA) and plasma transferred arc (PTA) welds made on Cu-9 Ni-6 Sn alloy was studied using a three-point, slow-bend test. The variables studied included the addition of manganese, phosphorus and zinc to the alloy, and the effect of shielding gases. A few welds were prepared in an environmental chamber containing argon to eliminate the possibility of atmospheric contamination of the weld pool. Gleeble simulations in an argon atmosphere were conducted on some of the heats to study the mechanism of crack formation in the welds. In addition, scanning electron microscope (SEM) and optical metallographic techniques were utilized to study selected welds and Gleeble specimens to characterize the crack morphology and porosity levels. Oxygen, nitrogen and hydrogen contents of the alloy were determined for the as-cast condition, the homogenized condition and for welded specimens.

The results indicated that the cause of weld failures in the bend test was the initiation of cracks from the tin-rich Gamma phase that formed along the grain bound-

aries in the partially melted zone. The addition of manganese and phosphorus to the alloy together with the use of argon-5% hydrogen shielding gas mixture in plasma arc welding produced ductile welds with reduced levels of porosity.

## Introduction

High spring strength, good formability coupled with high electrical conductivity and corrosion resistance make tin-modified copper-nickel alloys attractive for use in electronic connector applications. Typical applications of these alloys include items such as connectors, diaphragm members, spring components in electro-mechanical packages and ocean cable hardware (Refs. 1, 2). Alloys such as Cu-9Ni-6Sn and Cu-4Ni-8Sn (nominal compositions) are typically made by thin-section, continuous-slab casting because the solidification rates in this process minimize segregation of tin (Ref. 3). Otherwise, segregation of tin during solidification can lead to hot shortness and difficulties in homogenizing the cast structure.

The room-temperature microstructure of Cu-9Ni-6Sn as-cast alloy shows the presence of a tin-rich phase Gamma ( $\gamma$ ) in the interdendritic regions. As can be

seen from the phase diagram of Cu-9 Ni and Sn (Fig. 1), the tin-rich Gamma is an intermetallic compound of the type  $(\text{Cu}, \text{Ni})_3 \text{Sn}$ . The fact that the Gamma phase forms in the interdendritic regions suggests that it is the last-to-solidify constituent during the solidification of this alloy. Intermetallic compounds such as  $(\text{Cu}, \text{Ni})_3 \text{Sn}$  are brittle and often suffer crack initiation under stress. Therefore, the presence of Gamma phase in or near the weld can cause welds in Cu-9 Ni-6 Sn alloy to crack due to the initiation of microcracks at Gamma phase regions.

The continuously cast slabs in the Cu-Ni-Sn alloys are rolled to thinner gauges, which are heat treated to improve their ductility and welded to produce long coils. These long coils are then further cold rolled to final gauges. Because the welds see considerable amounts of bending during the coiling and uncoiling operations, it is important that the welds possess adequate bend ductility and strength to withstand a wide variety of stresses that they are subjected to during these operations. Many mechanical properties, such as fatigue strength and yield strength, of these copper-nickel-tin alloys have been studied by earlier researchers (Refs. 4, 5). However, no literature is available on the

## KEY WORDS

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GTA Welding  
Plasma Arc Welding

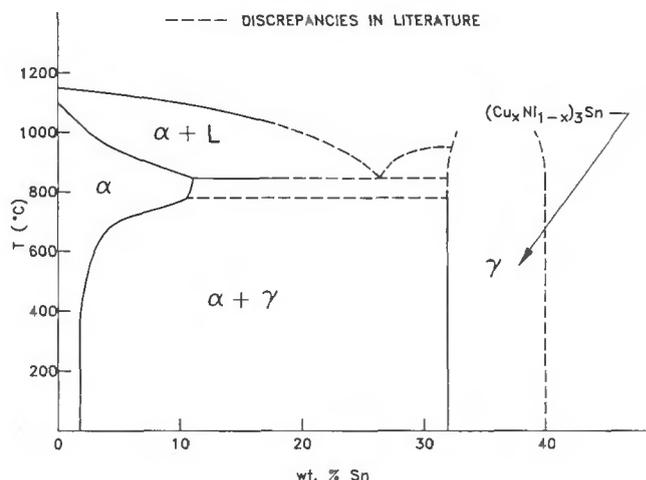


Fig. 1—Pseudo binary phase diagram of (Cu-9 Ni)-Sn.

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